

| | | | | |
|-----------------------------------|--|-------------------------|---|-------------|
| Notice of References Cited | | Application/Control No. | Applicant(s)/Patent Under Reexamination | |
| | | 10/648,377 | MORIYA, SEIJI | |
| Examiner | | Art Unit | | Page 1 of 1 |
| Jared J. Fureman | | 2876 | | |

U.S. PATENT DOCUMENTS

| * | | Document Number Country Code-Number-Kind Code | Date MM-YYYY | Name | Classification |
|---|---|--|-----------------|-------------------|----------------|
| | A | US-6,641,034 | 11-2003 | Oki et al. | 235/380 |
| | B | US-5,702,304 | 12-1997 | Acres et al. | 463/29 |
| | C | US-5,272,320 | 12-1993 | Hakamada, Ikuhiro | 235/380 |
| | D | US-2004/0007620 | 01-2004 | Hirasawa et al. | 235/449 |
| | E | US- | | | |
| | F | US- | | | |
| | G | US- | | | |
| | H | US- | | | |
| | I | US- | | | |
| | J | US- | | | |
| | K | US- | | | |
| | L | US- | | | |
| | M | US- | | | |

FOREIGN PATENT DOCUMENTS

| * | | Document Number Country Code-Number-Kind Code | Date MM-YYYY | Country | Name | Classification |
|---|---|--|-----------------|---------|-----------------|----------------|
| | N | WO 02/42990 A1 | 05-2002 | WO | Hirasawa et al. | ----- |
| | O | JP 2004-185513 A | 07-2004 | Japan | ----- | ----- |
| | P | | | | | |
| | Q | | | | | |
| | R | | | | | |
| | S | | | | | |
| | T | | | | | |

NON-PATENT DOCUMENTS

| * | | Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages) |
|---|---|---|
| | U | |
| | V | |
| | W | |
| | X | |

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.